

PCN No.: O000-PCN-PA202005-03

Product / Process Change Notice

Date: 2020-05-18

Change Title: To change the IC top marking company logo from Winbond to Nuvoton. Change Classification: ■ Major ☑ Minor Change item: □ Design □ Raw Material □ Wafer FAB □ Package Assembly □ Testing ☑ Others: logo change. Affected Product(s): All the package products with Winbond logo will be affected and the affected package type lists please refer to the Table I for more information. Description of Change(s): To align with the company logo change, Nuvoton logo plans to implement and shows on IC package top marking to recognize the change. As to the difference, please refer to the Fig. 1 for more details. Reason for Change(s): Due to the establishment of Nuvoton, the logo on package top marking will be introduced with new CIS (Coporate Identity System). Impact of Change(s): (positive & negative) Form: Please refer to the Fig. 1 for comparison Fit: No concern Function: No concern Reliability: No concern Qualification Plan/Results: No product quality qualification is required and the changes made only to the appearance of package. Implementation Plan: The Nuvoton company logo marking goods will be started to ship to customer from June 28, 2020. As to the old Winbond logo marking goods, they will be kept on shipping until the inventory has been depleted. If the customer has any question, please contact the local sales for more information. ☐ Date Code: _____ onward Lot No.: _____ onward Implemented date: Jun 28, 2020 Originator: H.Y. Lai / Q100 C.H. Shen/ Q000 Approval:(QRA Director) Name: HYLai TEL: 886-3-5770066 (ext. 31226) FAX: 886-3-5792673. **Contact for Questions** Address: No.4, Creation Rd. III Science-Based Industrial Park Hsinchu, Taiwan, R.O.C.. & Concerns E-mail: <u>hylai0@nuvoton.com.</u>



□ Approval □ 1	Disapproval	□ C	onditional Approv	/al:			<u>.</u>	
Date:	Dept. name:			Person in charge:				<u> </u>
Follow-up and Tracing A. copies to	y;							
FAB : □ Integration	1							
Test / Product: □ _							<u></u> ,	
Design/ Marketing								
Production control	Others: □							<u>·</u>
B. Changes: 1. Document / Test prog	ram:			I		ı		
Document No/ test program	Documen	Document name/ test program name			version		Completed date	Remark
				before	after			
NA NA			NA	NA	NA	NA	NA	



Table I: Affected part lists

Part No	Part No	Part No
W83527HG	W83627EHG	W83795ADG
W83601G	W83627HG-AW	W83795G
W83627DHG	W83627UHG	W83977AG-A
W83627DHG-P	W83782G	W83977EG-AW
W83627DHG-PT	W83793G	W83L603G

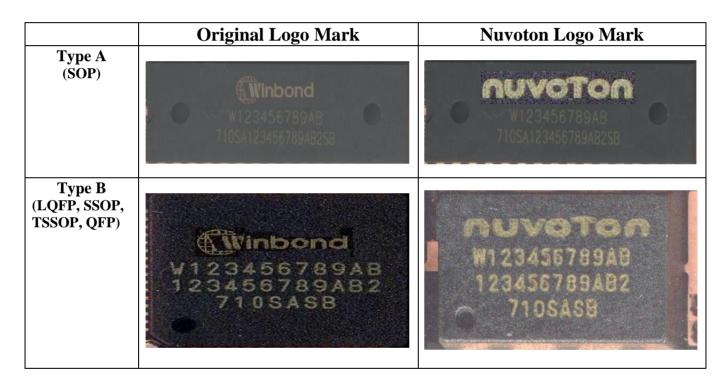


Fig. 1 The logo change from Winbond to Nuvoton is shown on IC top mark.